

		1.	2.2	
1		1 BER COLOR (4)	DIM L LEAD FREE OPTION	
\bigcirc	PRODUCT_NUME 68293-X01-	<u>3ER COLOR (4)</u> — – –7 0343- LT - GRAY – – –	DIM L LEAD FREE OPTION	
	68293-X02	80166 OFF WHITE		
	68293			
	68293-X04	701 BLACK	SEE NOTE 6 & 7	
	68293		BELOW OBS	
	68293-X07	70455 SILVER GRAY		
	68293			
	68293-X09	70419 PEBBLE GRAY		
А		· · · · · · · · · · · · · · · · · · ·		
	PIN LE			
	DASH No.	DIM L		E
	68293-0XX	.200/5.08		
	68293-1XX	.130/3.30		
	68293-2XX .270/6.86			
	DASH No. PLATING DESCRIPTION			(
	68293-X0X	30u" MIN (NOTE 3) OVER 5		L
	68293-X3X	30u" MIN (NOTE 3) OVER 5		
п	68293-X5X	, ,	50u" MIN Ni	
B				
U 4 1	NOTES:			
	1. Н	EADER SHROUD		
FCIconnect.		IAT'L: HIGH TEMPERATURE THERM IL—94V—0 RATED.	IOPLASTC	
FC		ROUND CONTACT		
()	MAT'L: COPPER ALLOY PLATING: 100–160u"/2.54–4.06u TIN.			
)		IGNAL CONTACT		
		AT'L: COPPER ALLOY LATING: PERFORMANCE PLATING W	ULL BE FITHER GOLD OR GYT	
		N CONTACT AREA OR TAIL, OPTIO		
<u>C</u>	(4) N	UMBERS SHOWN ARE FOR G.E. LI	EXAN AND ARE FOR REFERENCE ONLY	
П	5. THIS ASSEMBLY U.L. APPROVED PER FILE E66906 VOL. 1, SEC 84			
FC	AND CSA APPROVED PER MASTER FILE LR46923.			matil, cod
Copyright FCI	6 ADD LF SUFFIX AT THE END OF PART NUMBER FOR LEAD FREE OPTION.			ltrecn r
	7. TH	7. THE HOUSING WILL WITHSTAND EXPOSURE TO 260 C PEAK TEMPERATURE FOR 15 SECONDS IN A WAVE SOLDER APPLICATION WITH A 1.5mm		
Col	М	INIMUM THICK CIRCUIT BOARD. SEE	APPLICATION NOTES/PROCEDURES	

MINIMUM THICK CIRCUIT BOARD. SEE APPLICATION NOTES/PROCEDURES IF THEY ARE AVAILABLE.
(8) THIS PRODUCT MEETS EUROPEAN UNION DIRECTIVES AND OTHER COUNTRY REGULATION AS DESCRIBED IN GS-22-008.

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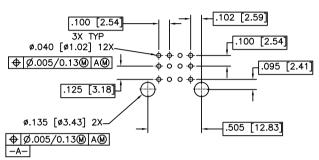
9. PRODUCT SPEC: GS-12-003

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form A3



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RECOMMENDED PCB LAYOUT

С

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В

